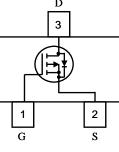




P-Channel Enhancement Mode Field Effect Transistor

Features	General Description
VDS (V) = -15 V	This P-Channel enhancement mode power FETs are produced
ID = -6.0 A	with high cell density, DMOS trench technology, which is
$R_{DS(ON)} = 28m \Omega$ @VGS = -4.5V	especially used to minimize on-state resistance.
$R_{DS(ON)} = 37m \Omega$ @VGs = -2.5V	This device is particularly suited for low voltage application
$R_{DS(ON)} = 50m \Omega$ @Vgs = -1.8V	such as portable equipment, power management and other
High density cell design for low RDS(ON).	battery powered circuits, and low in-line power loss are needed
	in a very small outline surface mount package.
Pin Configurations	
	D



SOT23

• Absolute Maximum Ratings @T_A=25°C unless otherwise noted

Parameter		Symbol	Ratings	Unit
Drain-Source Voltage		Vdss	-15	V
Gate-Source Voltage		Vgss	± 8	V
Drain Current	Continuous	۰ Id	-6.0	A
	Pulsed(1)		-20	
Power Dissipation		PD	350	mW
Operating and Storage Temperature Range		Tj,Tstg	-55 to 150	°C





Parameter Symbol **Test Conditions** Max Unit Min Тур **OFF CHARACTERISTICS** $V_{GS} = 0 V, I_D = -250 \mu A$ Drain-Source Breakdown Voltage V(BR)DSS -15 V $V_{DS} = -15V, V_{GS} = 0V$ Zero Gate Voltage Drain Current IDSS -1 μΑ $V_{GS} = +8 V, V_{DS} = 0 V$ Gate - Body Leakage, Forward IGSSF 100 nA $V_{GS} = -8 V$, $V_{DS} = 0 V$ -100 Gate - Body Leakage, Reverse nA IGSSR **ON CHARACTERISTICS (2)** V Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ -0.5 -0.7 -0.9 Vgs (TH) Vgs = -4.5 V, ID = -6.0 A 28 36 Vgs = -2.5 V, ID = -4.5 A 44 Static Drain-Source On-Resistance 37 mΩ RDS(ON) Vgs = -1.8 V, ID = -2.0 A 71 50 Forward Transconductance GFS $V_{DS} = -5 V$, $I_{D} = -2.8 A$ 4 6 S **DYNAMIC CHARACTERISTICS (3)** Input Capacitance Ciss 650 pF VDS = -6 V, VGS = 0 V, F = 1.0 **Output Capacitance** Coss 72 pF ---MHz **Reverse Transfer Capacitance** Crss 58 pF SWITCHING CHARACTERISTICS (3) Turn-On Delay Time TD(ON) $V_{DD} = -6 V, R_L = 6\Omega, I_D = -1.0 A,$ 20 -ns Turn-On Rise Time $V_{\text{GEN}} = -4.5 \text{ V}, \text{Rg} = 6 \Omega$ 10 T_R Turn-Off Delay Time V_{DD} = -6 V, R_L = 6 Ω , I_D = -1.0 A, 65 TD(OFF) --ns Turn-Off Fall Time $V_{GEN} = -4.5 V_{,RG} = 6 \Omega$ TF 45 DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS Drain-Source Diode Forward Current(4) -1.35 ls --А Drain-Source Diode Forward Voltage(2) Vsd Vgs = 0 V, Is = -0.75 A -0.6 -0.8 -1.3 V

Electrical Characteristics @T_A=25°C unless otherwise noted

Notes

1. Pulse width limited by maximum junction temperature.

2、Pulse test: PW \leq 300 μ s, duty cycle \leq 2%.

3、Guaranteed by design, not subject to production testing.

4, Surface Mounted on FR4 Board,T < 5 sec.



FS2233

Typical Performance Characteristics (TJ = 25 Noted)

